

Bench testing of new polarimeter with silicon photoelastic modulator for short wavelength FIR laser

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1. Objectives of Research



From measurement of the Faraday rotation α (polarimetry) and the electron density, the current (or the iota) profile can be evaluated. $\alpha \propto \lambda^2 [n_B_u dl]$ The electron density profile can be measured with a interferometer. To be free from fringe jump errors, which is caused by beam bending effect ($\Delta l/\lambda$), a short wavelength FIR laser is adopted. A CH_OD laser beams (57.2 and 47.7 µm) [1-4] suffer

a small beam bending and can compensate a phase error due to mechanical vibrations

2. Specification of PEM Polarimeter

2.1. Principle of PEM Polarimeter



2.2. Estimation of Error Terms

57.2 μm (ω,^h

In this research, polarimeter system

Polarization Rotation Method (counter-rotating circularly polarized beams)

Instability of beam pointing — change in interference — phase noises [5]

Simple optical system and good compatibility with an interferometer

We adopts PMM in the viewpoint of maintenance, compatibility with the

was no PEM in the FIR region. Hence we newly developed the PEM

57.2 µm (0,"+0."

47.7 μm (ω₀⁻¹+ω

interferometer, resolutions and long time phase stability. However, there

-D Local beat Interferometer

- Probe beat signal

(o_", o_')

→ The same optics

I(DC)

-Detector

High time resolution and multi-channel with low cost

Polarization Modulation Method (photoelactic modulator)

Good resolutions and long time stability [6]

and tested the polarimeter with it.

Multi-channel with higher cost than that of PRM

Low long time stability

Conceptual Design

CO, laser

FIR laser (Local)

FIR laser (Probe)

with the CH₂OD laser is developed.



 $\left[\frac{2A_{spu}J_{2}(\rho_{0})-J_{0}(\rho_{0})}{2}\right]$

4. Summarv

- . The Si PEM has been newly developed for a polarimeter using a short wavelength FIR laser, which is suitable for large fusion devices.
- The polarimeter with the new Si PEM can measure the polarization angle successfully.
- The measurement error of amplitude of a detector signal and the retardation results in non-linear errors in evaluated polarization angle · Since a multi-reflection in the photoelastic element also causes the deviation from an actual polarization angle, it should be suppressed by tilting the PEM or an AR-coating.

3. Experimental Results

3.1. Short wavelength FIR laser



• A phase error due to mechanical vibrations ($\Delta l / \lambda$) is significant in the case of a short wavelength interferometer.

Vibration compensation with a shorter wavelength interferometer (usually He-Ne laser, CW YAG laser, etc.)

However, complex system, uncompensated vibrations because of incompleteness of the beam paths (necessity of careful beam alignment)

• Intrinsic and simultaneous laser oscillation of wavelengths of 57.2 and 47.7 µm overcomes the problem of the short wavelength interferometer.

3.3. Test of Si PEM polarimeter



· Since visible light cannot pass though silicon, CW YAG laser (1.06 um) is used for beam alignment. It can be visualized with an IR sensor card and an Infrared viewer. · A Detector is a liquid helium cooled galliumdoped germanium photoconductor. · One wavelength is selected with a polarizer and tested separately; the polarization of two wavelength is orthogonal. . The Faraday rotation is simulated with a half wave plate made from crystal quartz.



3.2. Development of Silicon PEM

There was no PEM in the FIR region.

ρ₀=2.27 rad

Controlle

done vet.

572 um

O Min. of 2_w_ component

△ Max. of 2∞_ component

ළි 80

음 70

60

50

40

30

20

0



harmonic components, the PEM is tilted. Incident Anale (dea.)

• Even if the configuration with tilted PEM, transmissivity is 50 and 30 % for 57.2 and 47.7 μm, respectively. This is because the incident angles where the total intensity and the spurious second harmonic component take external values are different

Measurement test of the polarization angle

Error bars show errors in the polarization angle derived from electrical noises (±3 mV in the case of a time constant of 300 ms of lock-in amplifiers) in measured amplitudes of detected signals. Error bar changes according to the polarization angle.

An evaluated polarization angle shows good agreement with an actual polarization angle (estimated from the rotation angle of the half-wave plate) in a polarization angle is smaller than 70 deg when the spurious second harmonic component due to the modulated interference is minimized (

10 20 30 40 50 60 70 80 90 The large deviation when the spurious component is Actual Polarization Angle (deg.) maximized ().

There is the deviation in a polarization angle larger than 70 deg. even when the spurious component is minimized. The reason is speculated as follows. The reflectivity of s- and p- polarization components is slightly different. Hence, the spurious component might increases when the polarization rotates.

We can evaluated actual polarization angle from non-linear relationship between evaluated and actual polarization angle by a calibration experiment. However, the cause should be eliminated because slight change in the incident beam make the calibration formula different.

Plans of AR-coating is going.



thick width is O.K., but no data of n_{AR} and absorption for 57 µm, weak adhesion? SiO₂ [10] $d_{AR} = 6.8 \ \mu m \ (n_{AR} = 2.10)$

strong adhesion, but the stress is so strong that it may cause photoelastic effect by itself. Reflectivity expected to be reduced to about 2% from 30% with these coatings.

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